

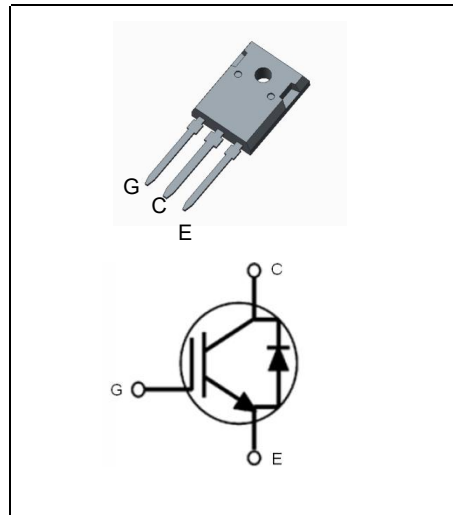
650V 80A FieldStop Trench IGBT

Description

The device is designed by advanced FieldStop Trench technology process. This IGBT offer low $V_{CE(sat)}$, high speed switching performance and excellent quality for application such as PFC, UPS, Welder, PV Inverter, Solar Inverter and other switching applications.

Features

- FieldStop Trench Technology, Positive temperature coefficient
- $V_{CE(sat)}=1.45V@I_C=80A$
- $t_{rr}=50ns$ (typ.)
- High Speed Switching & Low Power Loss
- High Input Impedance



Applications

- PFC, UPS, Welder, PV Inverter, Solar Inverter

Absolute Maximum Ratings

| Symbol | Parameter | Ratings | Unit | |
|-----------|--------------------------------------|-------------------|------------|---|
| V_{CES} | Collector to Emitter Voltage | 650 | V | |
| V_{GES} | Gate to Emitter Voltage | ± 20 | V | |
| I_C | Collector Current | $T_C=25^\circ C$ | 160 | A |
| | | $T_C=100^\circ C$ | 80 | A |
| I_{CM} | Pulsed Collector Current | 240 | A | |
| I_F | Diode Continuous Forward Current | $T_C=100^\circ C$ | 80 | A |
| I_{FM} | Diode Maximum Forward Current | 400 | A | |
| P_D | Maximum Power Dissipation | $T_C=25^\circ C$ | 428 | W |
| | | $T_C=100^\circ C$ | 214 | W |
| T_J | Operating Junction Temperature Range | -50~+175 | $^\circ C$ | |
| T_{STG} | Storage Temperature Range | -50~+150 | $^\circ C$ | |

Thermal Characteristics

| Symbol | Parameter | Ratings | Unit |
|-----------------------|--|---------|--------------|
| $R_{th(J-C)}$ (IGBT) | Thermal Resistance, Junction to case for IGBT | 0.35 | $^\circ C/W$ |
| $R_{th(J-C)}$ (Diode) | Thermal Resistance, Junction to case for Diode | 0.45 | $^\circ C/W$ |
| $R_{th(J-A)}$ | Thermal Resistance, Junction to Ambient | 40 | $^\circ C/W$ |

Electrical Characteristics of IGBT @ $T_C=25^\circ\text{C}$ unless otherwise noted

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|---------------|---|--|------|------|-----------|---------|
| BV_{CES} | Collector to Emitter Breakdown Voltage | $V_{GE}=0V, I_C=250\mu A$ | 650 | - | - | V |
| $V_{CE(sat)}$ | Collector to Emitter Saturation Voltage | $I_C=80A, V_{GE}=15V$ | - | 1.45 | 1.8 | V |
| | | $I_C=80A, V_{GE}=15V, T_C=125^\circ\text{C}$ | - | 1.7 | - | V |
| $V_{GE(th)}$ | Gate Threshold Voltage | $V_{CE}=V_{GE}, I_C=250\mu A$ | 4.0 | 4.5 | 6.0 | V |
| I_{CES} | Zero Gate Voltage Collector Current | $V_{CE}=V_{CES}, V_{GE}=0V$ | - | - | 10 | μA |
| I_{GES} | Gate to Emitter Leakage Current | $V_{GE}=V_{GES}, V_{CE}=0V$ | - | - | ± 250 | nA |

Electrical Characteristics of Diode @ $T_C=25^\circ\text{C}$ unless otherwise noted

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|----------|-------------------------------------|----------------------------------|------|------|------|------|
| V_F | Diode Forward Voltage | $I_F=80A$ | - | 1.66 | 1.9 | V |
| | | $I_F=80A, T_C=125^\circ\text{C}$ | - | 1.5 | - | V |
| t_{rr} | Diode Reverse Recovery Time | $I_F=80A, di/dt=-200A/\mu s$ | - | 50.0 | 75.0 | ns |
| I_{rr} | Diode Peak Reverse Recovery Current | | - | 9.0 | - | A |
| Q_{rr} | Diode Reverse Recovery Charge | | - | 1.4 | - | nC |

Switching Characteristics @ $T_C=25^\circ\text{C}$ unless otherwise noted

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit | |
|--------------|-------------------------------|--|---|-------|-------|------|----|
| $t_{d(on)}$ | Turn-on Delay Time | $I_C=80A, V_{CC}=325V, V_{GE}=15V, R_G=7\Omega, \text{Inductive Load}, T_C=25^\circ\text{C}$ | - | 31.4 | - | ns | |
| t_r | Rising Time | | - | 38.2 | - | ns | |
| $t_{d(off)}$ | Turn-off Delay Time | | - | 133.6 | - | ns | |
| t_f | Falling Time | | - | 38.8 | - | ns | |
| E_{on} | Turn-on Switching Loss | | - | 1.50 | - | mJ | |
| E_{off} | Turn-off Switching Loss | | - | 0.69 | - | mJ | |
| E_{ts} | Total Switching Loss | | - | 2.17 | - | mJ | |
| $t_{d(on)}$ | Turn-on Delay Time | | $I_C=80A, V_{CC}=325V, V_{GE}=15V, R_G=7\Omega, \text{Inductive Load}, T_C=125^\circ\text{C}$ | - | 30.8 | - | ns |
| t_r | Rising Time | | | - | 61.4 | - | ns |
| $t_{d(off)}$ | Turn-off Delay Time | | | - | 144.2 | - | ns |
| t_f | Falling Time | - | | 54.0 | - | ns | |
| E_{on} | Turn-on Switching Loss | - | | 2.00 | - | mJ | |
| E_{off} | Turn-off Switching Loss | - | | 1.12 | - | mJ | |
| E_{ts} | Total Switching Loss | - | | 3.02 | - | mJ | |
| C_{ies} | Input Capacitance | $V_{GE}=0V, V_{CE}=25V, f=1.0\text{MHz}$ | - | 3680 | - | pF | |
| C_{res} | Reverse Transfer Capacitance | | - | 109 | - | pF | |
| C_{oes} | Output Capacitance | | - | 15 | - | pF | |
| tsc | Short Circuit With stand Time | $V_{CC}=325V, V_{GE}=15V$ | 10 | - | - | us | |

Typical Performance Characteristics

Fig. 1. Typical Output Characteristics

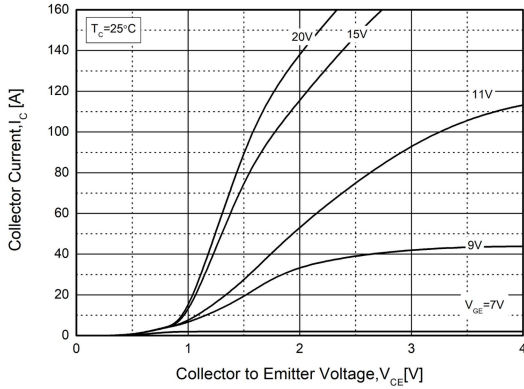


Fig. 2. Typical Saturation Voltage Characteristics

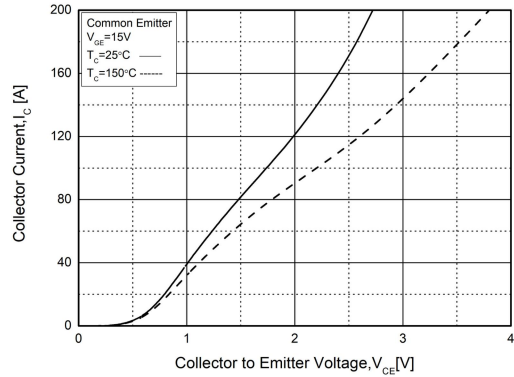


Fig. 3. Typical Saturation Voltage vs. T_c

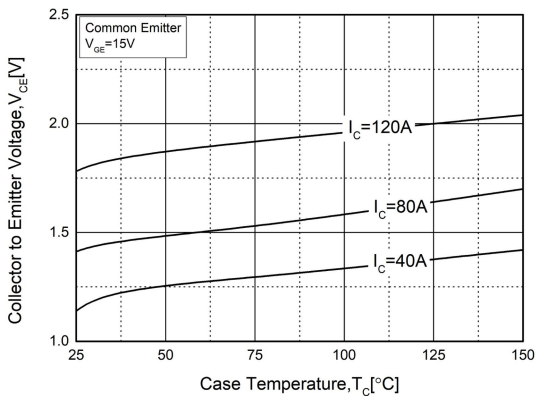


Fig. 4. Diode Forward Characteristics

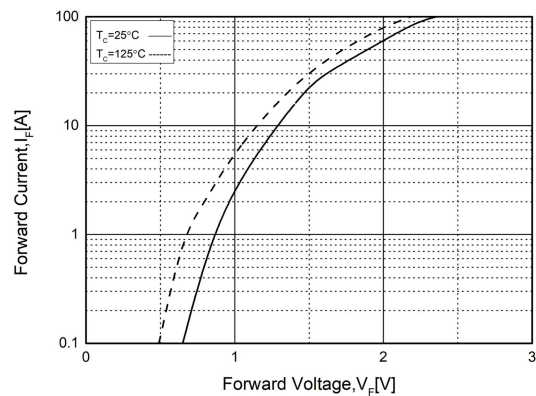


Fig. 5. Typical Capacitance Characteristics

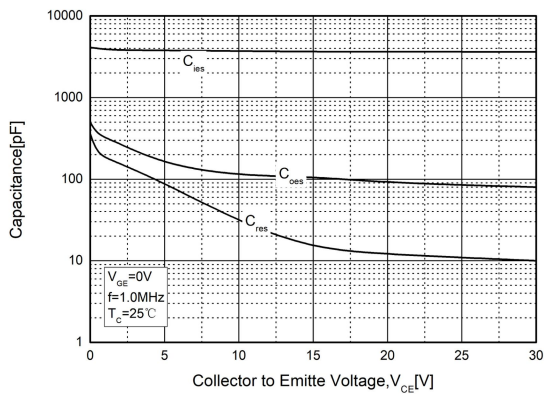
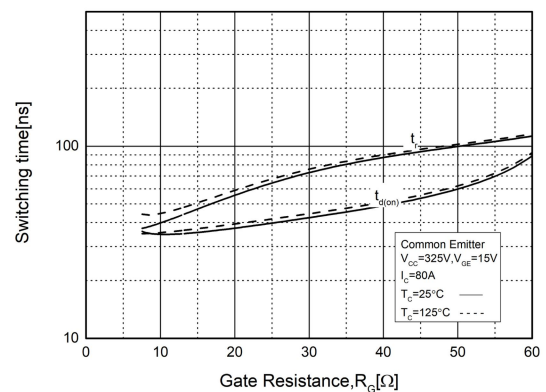
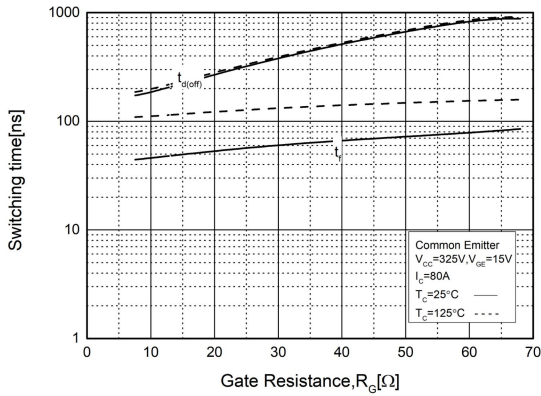
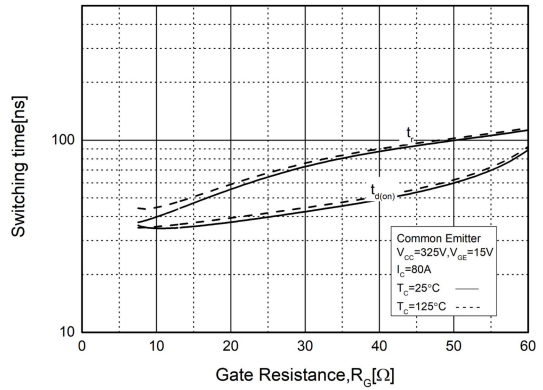
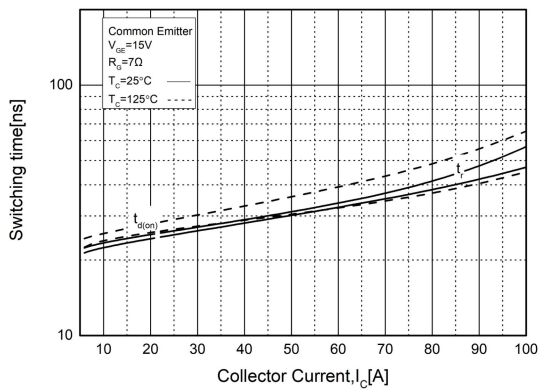
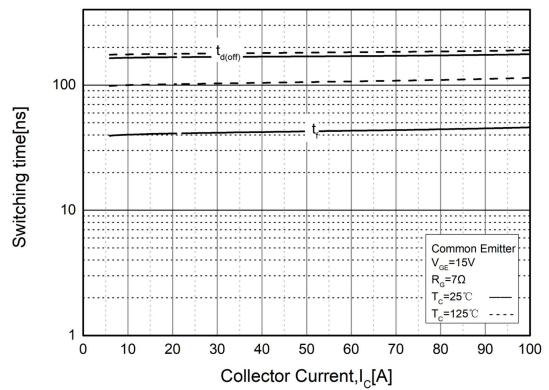
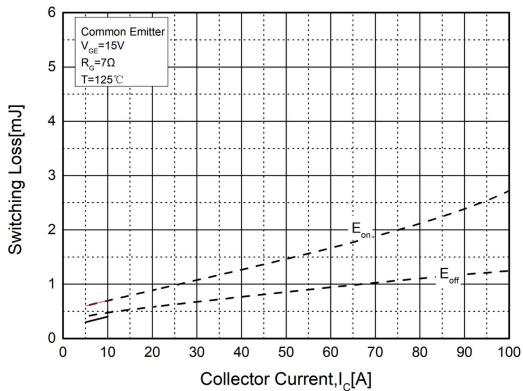


Fig. 6. Turn-on Characteristics vs. R_G



Typical Performance Characteristics
Fig. 7. Turn-off Characteristics vs. R_G

Fig. 8. Switching Loss vs. R_G

Fig. 9. Turn-on Characteristics vs. I_C

Fig. 10. Turn-off Characteristics vs. I_C

Fig. 11. Switching Loss vs. I_C


Package Dimensions

TO-247

(Dimensions in Millimeters)

